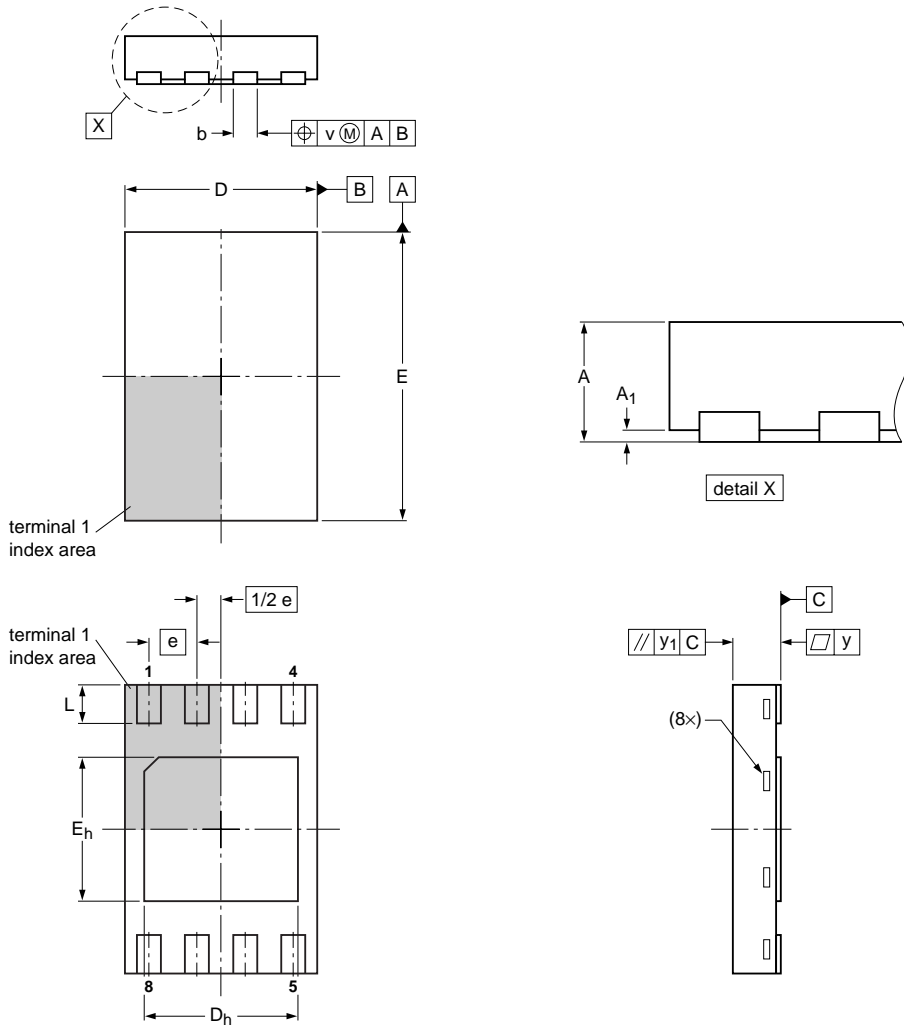


HXSON8: plastic thermal enhanced extremely thin small outline package; no leads;
8 terminals; body 2 x 3 x 0.5 mm

SOT1052-1



DIMENSIONS (mm are the original dimensions)

UNIT	A ⁽¹⁾	A ₁	b	D	D ₁	E	E ₁	e	L	v	y	y ₁
mm	max	0.5	0.04	0.3	2.1	1.6	3.1	1.6	0.45	0.1	0.05	0.05
	nom				2.0		3.0					
	min			0.2	1.9	1.4	2.9	1.4	0.35			

Note

1. Dimension A is including plating thickness. The package footprint is compatible with JEDEC MO229

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
SOT1052-1		MO-229			08-01-11 08-03-11